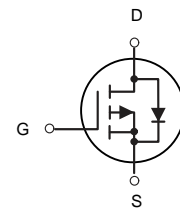
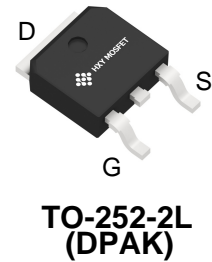




Description

The DMP4051LK3-13 uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a Battery protection or in other Switching application.



P-Channel MOSFET

General Features

$V_{DS} = -40V$ $I_D = -25A$

$R_{DS(ON)} < 44\ m\Omega @ V_{GS}=10V$

Application

Battery protection

Load switch

Uninterruptible power supply

Ordering Information

| Product ID | Pack | Brand | Qty(PCS) |
|---------------|-----------------|------------|----------|
| DMP4051LK3-13 | TO-252-2L(DPAK) | HXY MOSFET | 2500 |

Absolute Maximum Ratings ($T_C=25^\circ C$ unless otherwise noted)

| Symbol | Parameter | Rating | Units |
|---------------------------------------|--|------------|-------|
| V _{DS} | Drain-Source Voltage | -40 | V |
| V _{GS} | Gate-Source Voltage | ± 25 | V |
| I _D @T _C =25°C | Continuous Drain Current, V _{GS} @ 10V ¹ | -25 | A |
| I _D @T _C =100°C | Continuous Drain Current, V _{GS} @ 10V ¹ | -12 | A |
| I _{DM} | Pulsed Drain Current ² | -40 | A |
| P _D @T _C =25°C | Total Power Dissipation ⁴ | 8 | W |
| T _{STG} | Storage Temperature Range | -55 to 150 | °C |
| T _J | Operating Junction Temperature Range | -55 to 150 | °C |
| R _{θJA} | Thermal Resistance Junction-ambient ¹ | 62 | °C/W |
| R _{θJC} | Thermal Resistance Junction-Case ¹ | 18.8 | °C/W |



Electrical Characteristics (T_J=25°C unless otherwise specified)

| Symbol | Parameter | Test Condition | Min. | Typ. | Max. | Units |
|---|---|---|------|------|------|-------|
| Off Characteristic | | | | | | |
| V _{(BR)DSS} | Drain-Source Breakdown Voltage | V _{GS} =0V, I _D = -250μA | -40 | - | - | V |
| I _{DSS} | Zero Gate Voltage Drain Current | V _{DS} = -40V, V _{GS} =0V | - | - | -1 | μA |
| I _{GSS} | Gate to Body Leakage Current | V _{DS} =0V, V _{GS} = ±20V | - | - | ±100 | nA |
| On Characteristics | | | | | | |
| V _{GS(th)} | Gate Threshold Voltage | V _{DS} =V _{GS} , I _D = -250μA | -1.0 | -1.6 | -2.5 | V |
| R _{DS(on)} | Static Drain-Source on-Resistance <small>note3</small> | V _{GS} = -10V, I _D = -8A | - | 31 | 44 | mΩ |
| | | V _{GS} = -4.5V, I _D = -5A | - | 44 | 60 | |
| Dynamic Characteristics | | | | | | |
| C _{iss} | Input Capacitance | V _{DS} = -20V, V _{GS} =0V, f=1.0MHz | - | 1034 | - | pF |
| C _{oss} | Output Capacitance | | - | 107 | - | pF |
| C _{rss} | Reverse Transfer Capacitance | | - | 79.5 | - | pF |
| Q _g | Total Gate Charge | V _{DS} = -20V, I _D = -5A, V _{GS} = -10V | - | 20 | - | nC |
| Q _{gs} | Gate-Source Charge | | - | 3.5 | - | nC |
| Q _{gd} | Gate-Drain("Miller") Charge | | - | 4.2 | - | nC |
| Switching Characteristics | | | | | | |
| t _{d(on)} | Turn-on Delay Time | V _{DD} = -20V, I _D = -5A, V _{GS} = -10V, R _{GEN} =2.5Ω | - | 8 | - | ns |
| t _r | Turn-on Rise Time | | - | 15 | - | ns |
| t _{d(off)} | Turn-off Delay Time | | - | 23 | - | ns |
| t _f | Turn-off Fall Time | | - | 9 | - | ns |
| Drain-Source Diode Characteristics and Maximum Ratings | | | | | | |
| I _S | Maximum Continuous Drain to Source Diode Forward Current | | - | - | -23 | A |
| I _{SM} | Maximum Pulsed Drain to Source Diode Forward Current | | - | - | -40 | A |
| V _{SD} | Drain to Source Diode Forward Voltage | V _{GS} =0V, I _S = -10A | - | -0.8 | -1.2 | V |
| t _{rr} | Reverse Recovery Time | V _{GS} =0V, I _S =-5A, | - | 29 | - | ns |
| Q _{rr} | Reverse Recovery Charge | di/dt=100A/μs | - | 20 | - | nC |

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

2. EAS condition: T_J= 25°C, V_{DD}= -20V, V_G= -10V, L=0.5mH, R_G= 25Ω, I_{AS}= -10.5A

3. Pulse Test: Pulse Width≤300μs, Duty Cycle≤2%



Typical Performance Characteristics

Figure 1: Output Characteristics

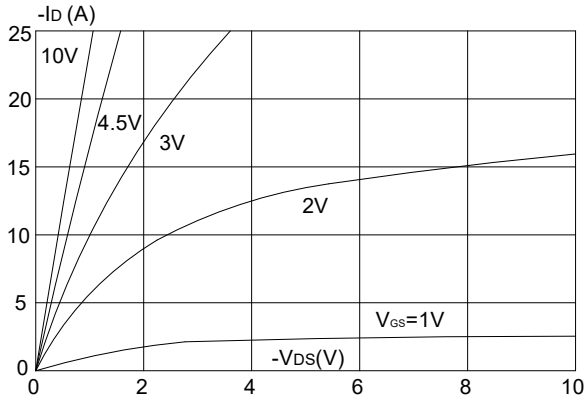


Figure 2: Typical Transfer Characteristics

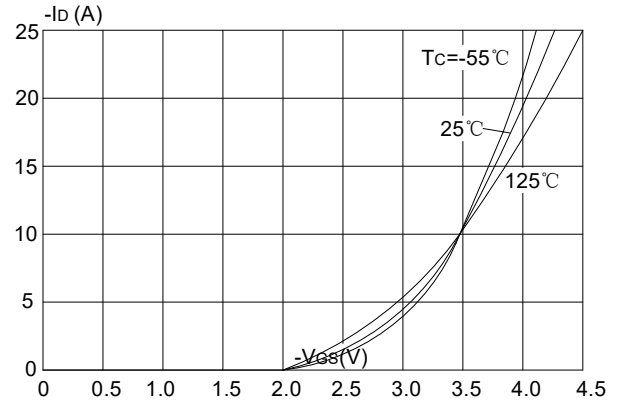


Figure 3: On-resistance vs. Drain Current

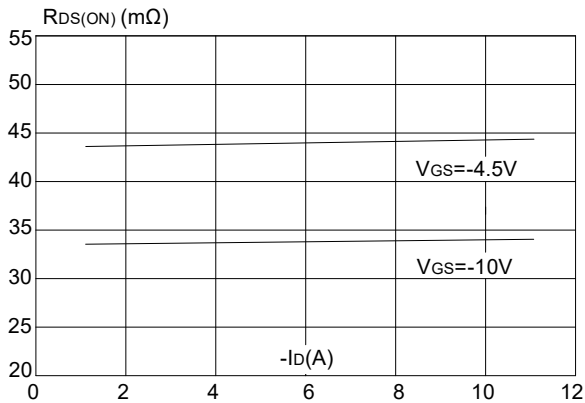


Figure 4: Body Diode Characteristics

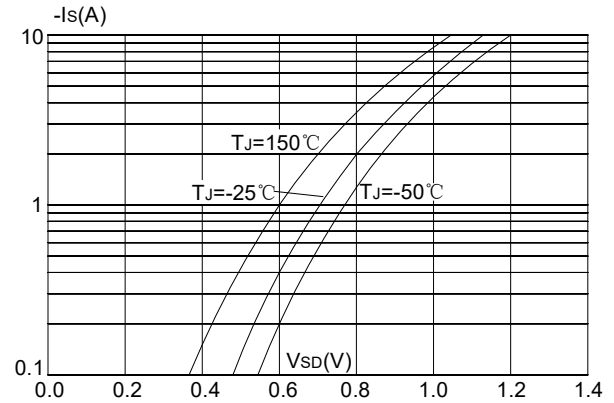


Figure 5: Gate Charge Characteristics

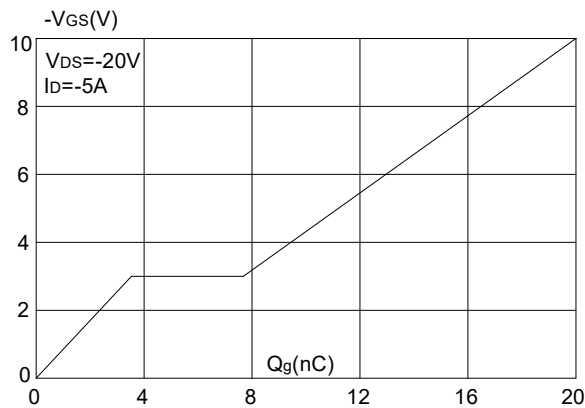


Figure 6: Capacitance Characteristics

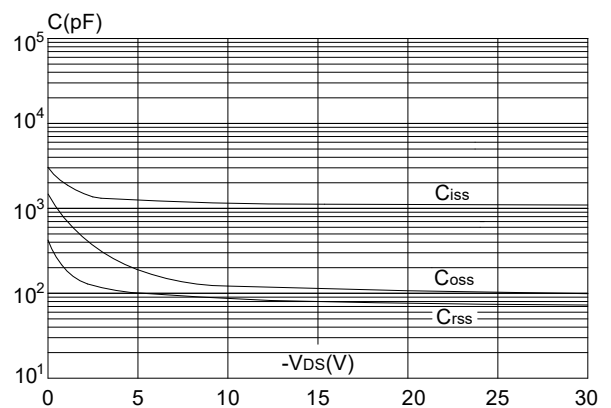




Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

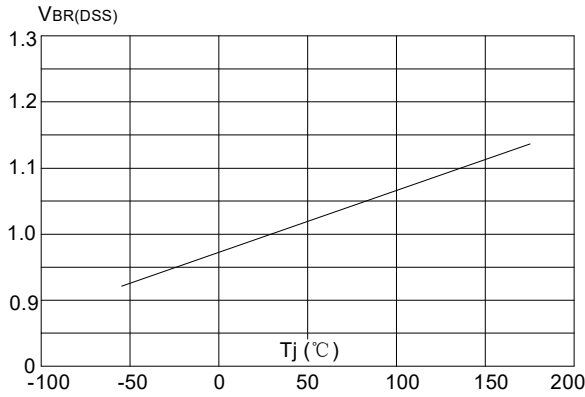


Figure 8: Normalized on Resistance vs. Junction Temperature

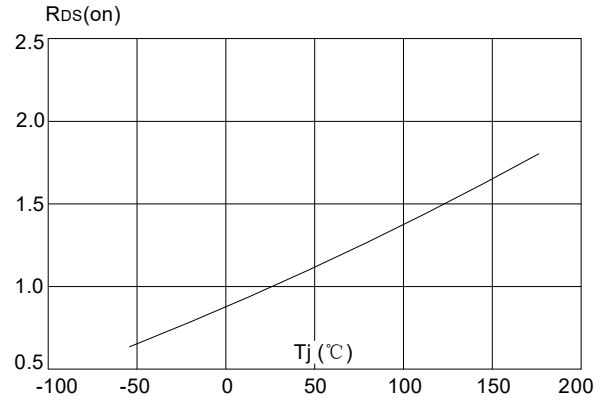


Figure 9: Maximum Safe Operating Area

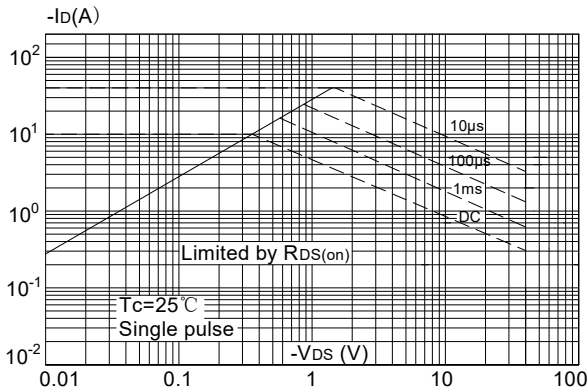


Figure 10: Maximum Continuous Drain Current vs. Case Temperature

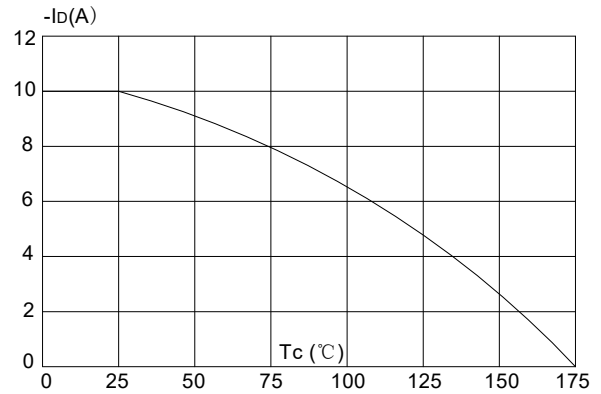
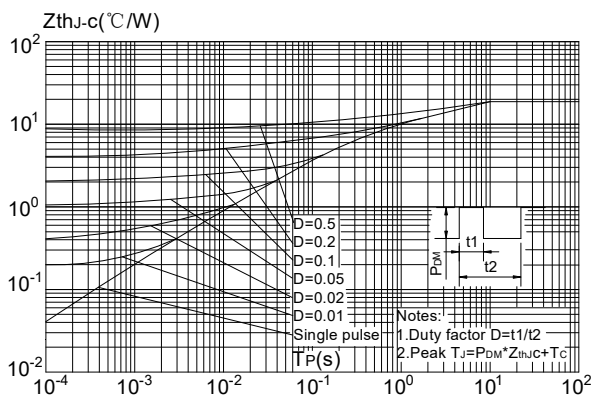


Figure.11: Maximum Effective Transient Thermal Impedance, Junction-to-Case





Test Circuit

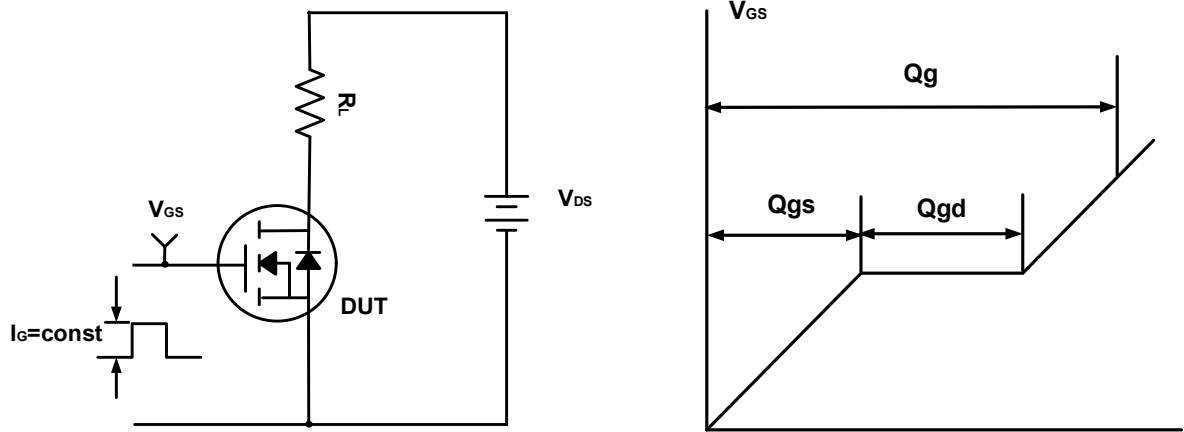


Figure A. Gate Charge Test Circuit & Waveforms

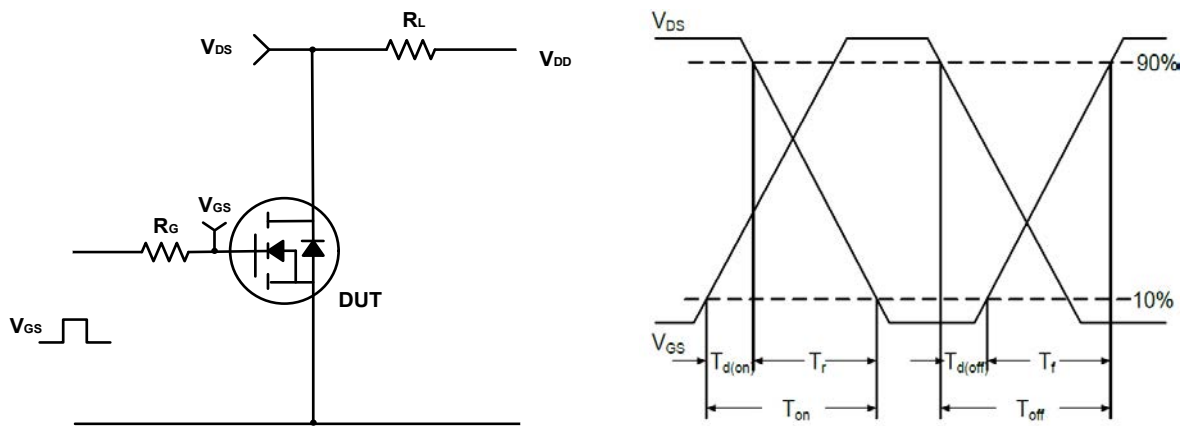


Figure B. Switching Test Circuit & Waveforms

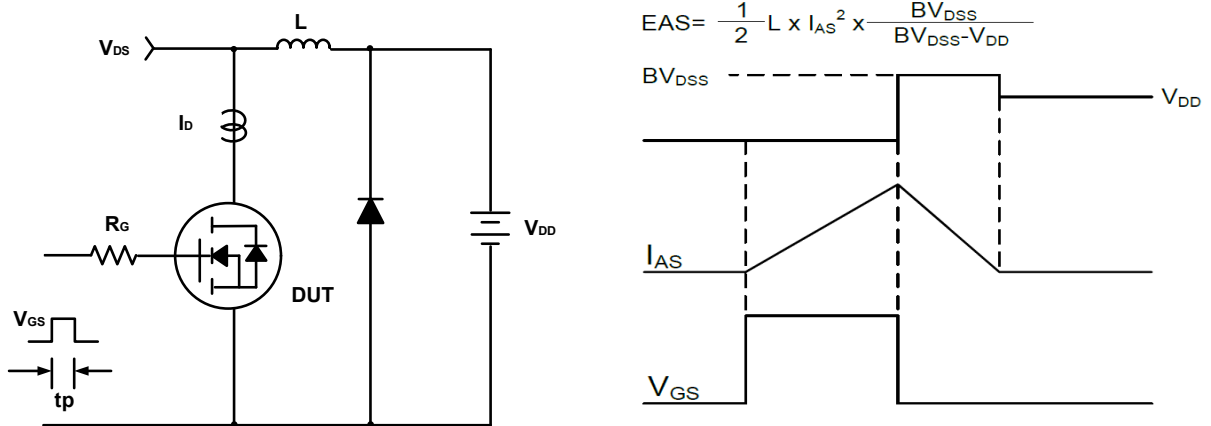
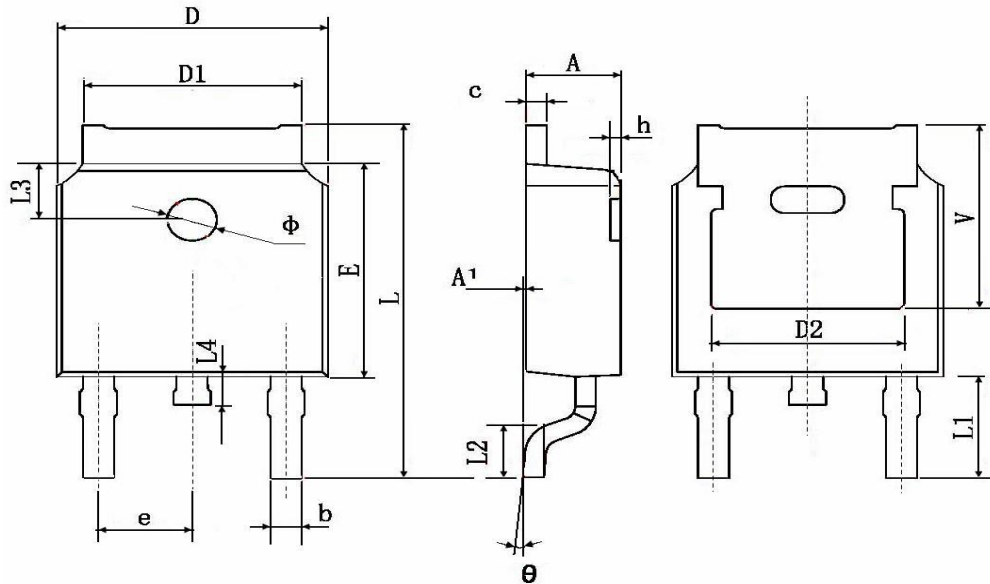


Figure C. Unclamped Inductive Switching Circuit & Waveforms



TO-252-2L(DPAK) Package Information



| Symbol | Dimensions In Millimeters | | Dimensions In Inches | |
|--------|---------------------------|--------|----------------------|-------|
| | Min. | Max. | Min. | Max. |
| A | 2.200 | 2.400 | 0.087 | 0.094 |
| A1 | 0.000 | 0.127 | 0.000 | 0.005 |
| b | 0.660 | 0.860 | 0.026 | 0.034 |
| c | 0.460 | 0.580 | 0.018 | 0.023 |
| D | 6.500 | 6.700 | 0.256 | 0.264 |
| D1 | 5.100 | 5.460 | 0.201 | 0.215 |
| D2 | 4.830 TYP. | | 0.190 TYP. | |
| E | 6.000 | 6.200 | 0.236 | 0.244 |
| e | 2.186 | 2.386 | 0.086 | 0.094 |
| L | 9.800 | 10.400 | 0.386 | 0.409 |
| L1 | 2.900 TYP. | | 0.114 TYP. | |
| L2 | 1.400 | 1.700 | 0.055 | 0.067 |
| L3 | 1.600 TYP. | | 0.063 TYP. | |
| L4 | 0.600 | 1.000 | 0.024 | 0.039 |
| Φ | 1.100 | 1.300 | 0.043 | 0.051 |
| θ | 0° | 8° | 0° | 8° |
| h | 0.000 | 0.300 | 0.000 | 0.012 |
| V | 5.350 TYP. | | 0.211 TYP. | |



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